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October 20, 2003

MAIL STOP PATENT APPLICATION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450



Re: Application of Hajime SAIKI and Michitoshi NAKATA
SOLDER PASTE PRINTING METHOD, SOLDER PASTE PRINTING
APPARATUS, AND METHOD FOR MANUFACTURING A WIRING
SUBSTRATE HAVING SOLDER-PRINTED LAYERS
Assignee: NGK SPARK PLUG CO., LTD.
Our Ref. Q78059

Dear Sir:

Attached hereto is the application identified above comprising fifty-seven (57) sheets of the specification, including the claims and abstract and four (4) sheets of drawings. **Copies of an executed Declaration and Power of Attorney and Assignment will be submitted at a later date.** Also enclosed is an Information Disclosure Statement and PTO/SB/08 A & B (modified).

The Government filing fee is calculated as follows:

Total claims	<u>12</u>	- 20	=	<u> </u>	x	\$18.00	=	<u> </u>	\$0.00
Independent claims	<u>3</u>	- 3	=	<u> </u>	x	\$86.00	=	<u> </u>	\$0.00
Base Fee									\$770.00

TOTAL FEE

\$770.00

A check for the statutory filing fee of \$770.00 is attached. The USPTO is directed and authorized to charge all required fees, except for the Issue Fee and the Publication Fee, to Deposit Account No. 19-4880. Please also credit any overpayments to said Deposit Account. A duplicate copy of this transmittal letter is attached.



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SUGHRUE MION, PLLC

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Priority is claimed from:

<u>Country</u>	<u>Application No</u>	<u>Filing Date</u>
JAPAN	2002-304848	October 18, 2002
JAPAN	2003-333578	September 25, 2003

The priority documents will be filed at a later date.

Respectfully submitted,
SUGHRUE MION, PLLC

Attorneys for Applicant

By: John Callahan Reg. No. 32,607
for Mark Boland
Registration No. 32,197

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